

NanoCOM-CV

B1.0

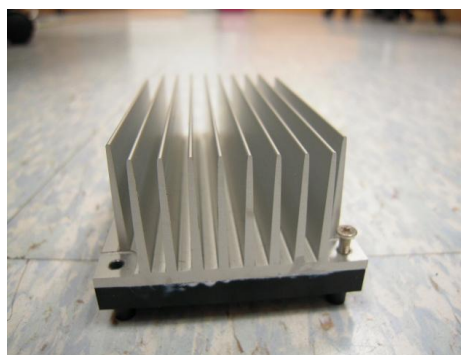
Thermal Image Analysis Report

| | | | | |
|----------------------------|--|-------|-------|-------------|
| Summary | <input type="checkbox"/> Pass <input type="checkbox"/> Fail <input checked="" type="checkbox"/> Pass with Deviation Comment: <u>Temperature at 8 components were estimated to be in marginal temperature points in comparion with components datasheets.</u> | | | |
| Test Result Summary | | | | |
| | Critical | Major | Minor | Enhancement |
| Defect Found | 0 | 0 | 0 | 8 |
| Defect Unsolved | 0 | 0 | 0 | 8 |

| | | |
|----------------|----------|---------------|
| Issue date | Approval | Test Engineer |
| 2012 / 11 / 12 | Tom Lin | Clement Chien |

Sample Configuration & Quantity Under Test

- **Model name** : NanoCOM-CV
- **CPU** : Intel Cedarview CPU N2600 / 1.6GHz
- **Chipset** : NM10 Express Chipset INTEL CG82NM10 SLGXX
- **Memory** : DDR3-SDRAM.256Mx8.1.5V.SAMSUNG.K4B2G0846D-HCH9
- **SATA HDD** : Seagate 5VGBKCDQ 2.5" 160GB
- **BIOS** : NanoCOM-CV R0.4
- **Test Software** : Windows 7 / Run PassMark Burn In Test 7.0 Pro
- **Power** : AT Power
- **Heat Sink:**



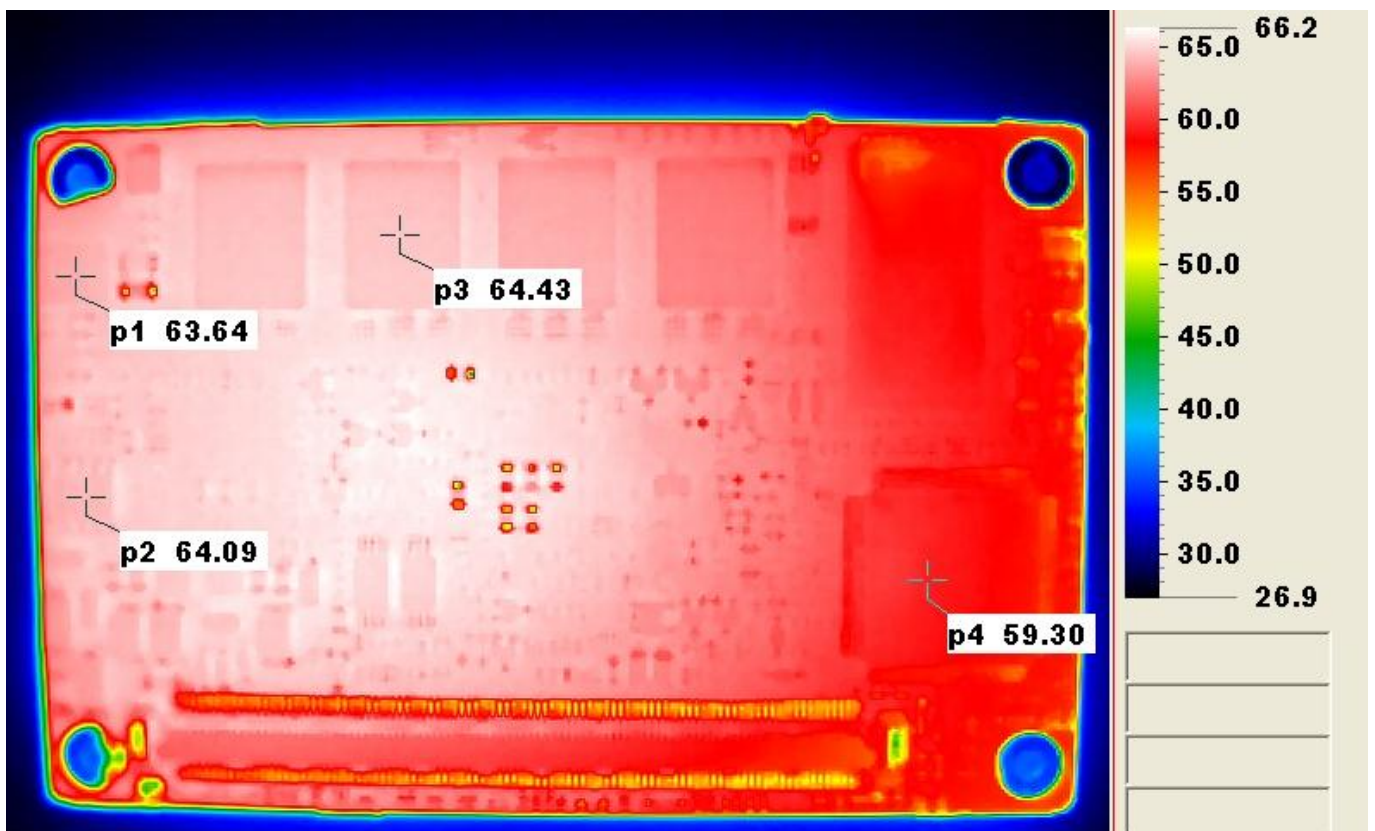
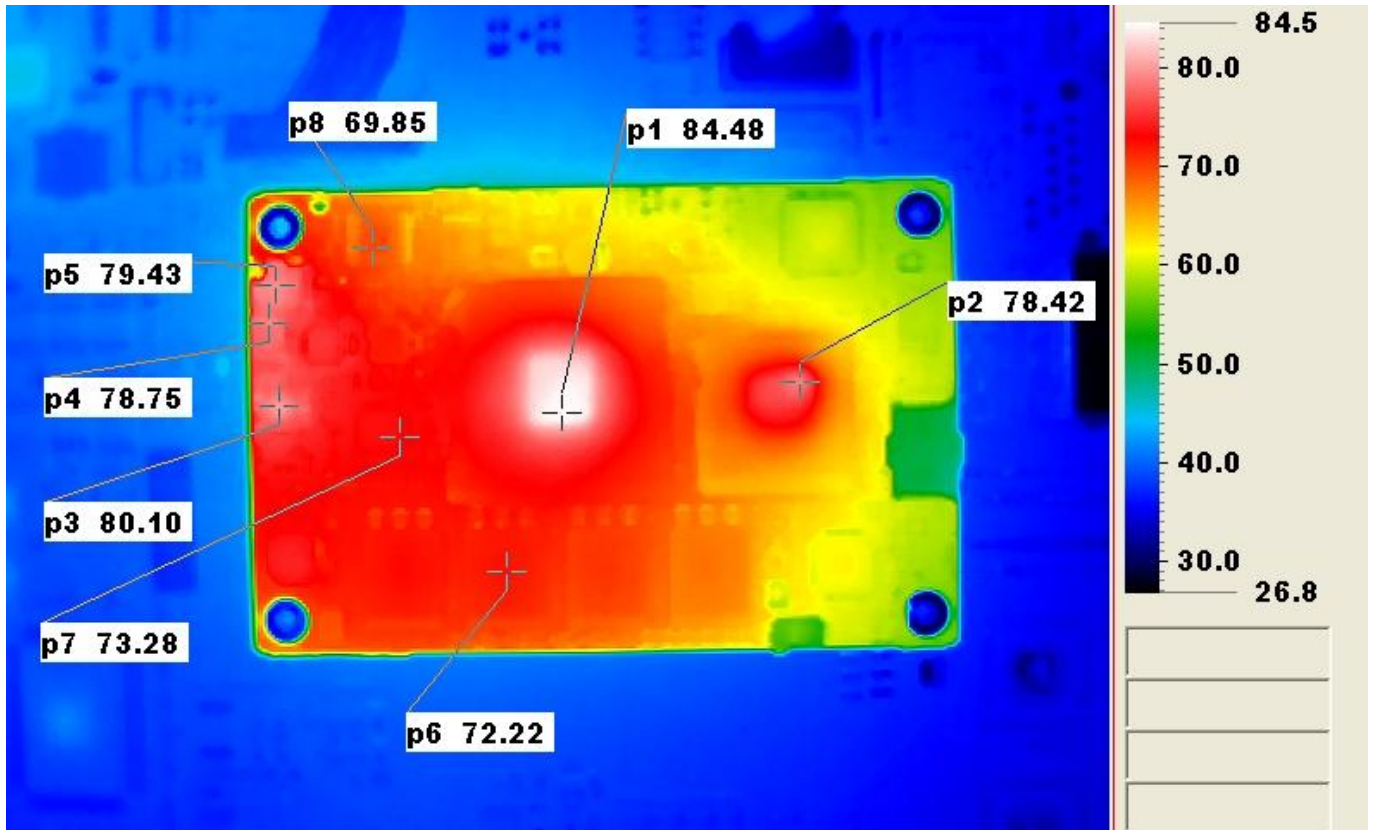
Thermal Image Analysis

1. Test Date: 2012-11-09
2. Test Product: NanoCOM-CV
3. Test Site: AAEON Internal Lab.
4. Temperature Measurement:
 - 4.1. 40 Channel Thermal Recorder:
 - 4.1.1 YOKOGAWA Inc,
 - 4.2.2 Model: DA100-13-1D
Date of Calibration: 2011/10/12
Serial Number: 12A323190
 - 4.2. IR Scanner: Infrared Camera
 - 4.2.1 NIPPON AVIONICS CO., LTD.
 - 4.2.2 Model: TVS-100
Date of Calibration: 2011/07/11
Serial Number: 0179L2746
5. Test Condition:

Component Side-1 (Test by DA-100): 25.0°C With Heat Sink
6. Take Picture Time:

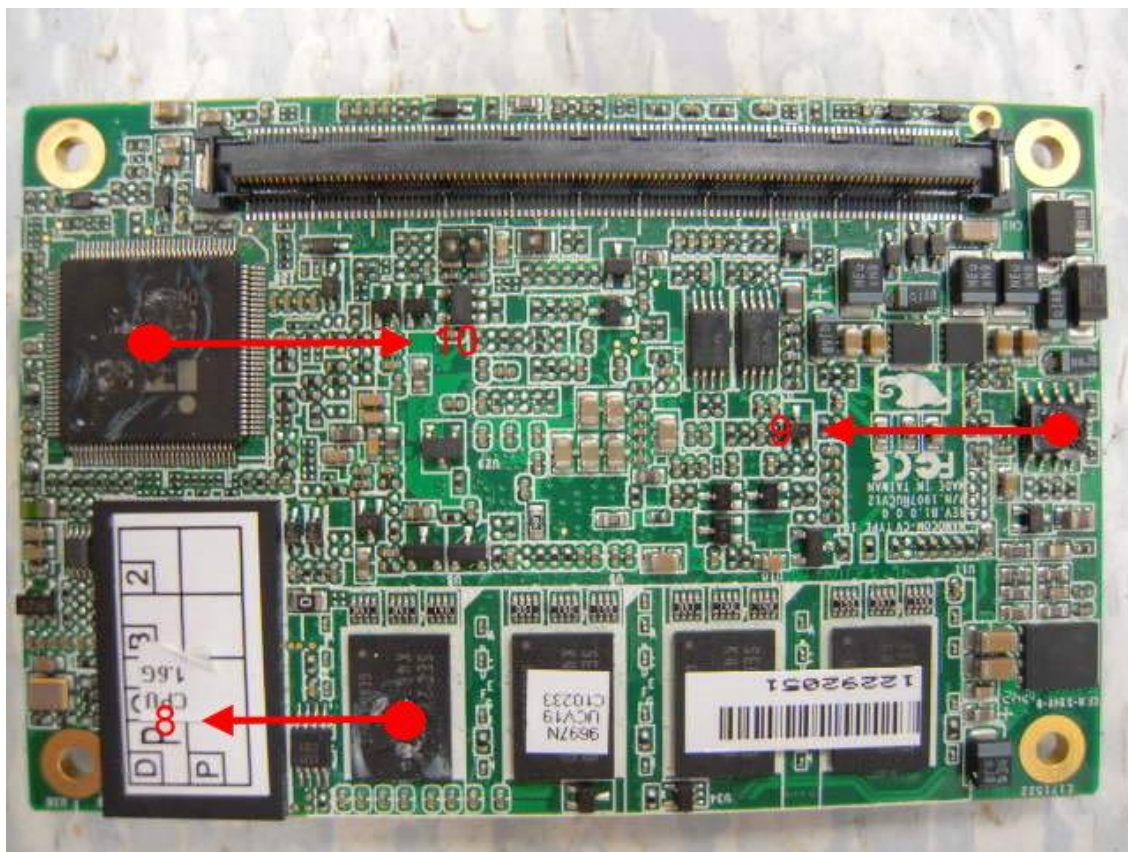
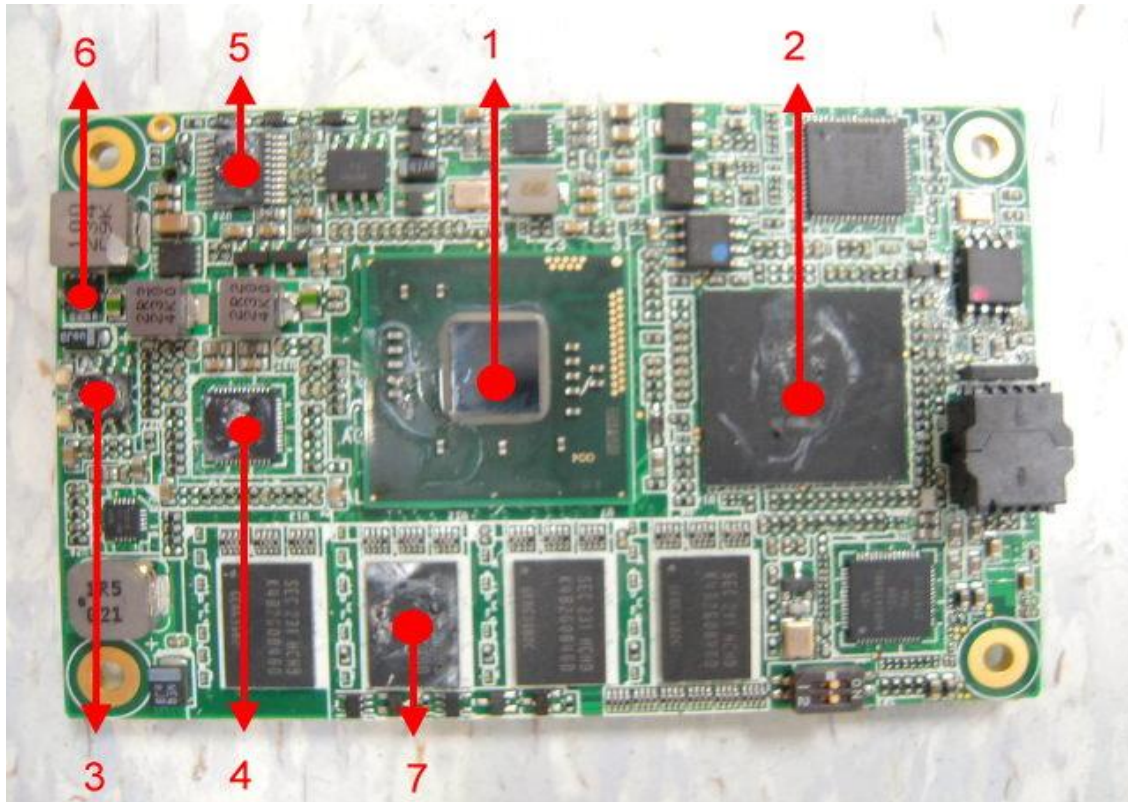
After power on 2 hours

Temperature Profile Test:
Component Side:



Terminal Recorder:

Measuring Thermal Couple Position :



Using YOKOGAWA / DARWIN DA100-100-13-1D test

| Point | Position | Describe | Tc (*1) (°C) | Tm (*2) Measured Under | | Note |
|-------|----------|--|-----------------|---------------------------|------|------|
| | | | | 25°C | 55°C | |
| 1 | CPU | (TF)INTEL.Cedarview CPU.1.6GHz.N2600. | 100 | 57.4 | 92.4 | |
| 2 | U1 | (TF)NM10 Express Chipset.INTEL.CG82NM10.SLGXX | 115 | 55.5 | 90.5 | |
| 3 | U27 | (TF)4A.0.33V.Low dropout Linear Regulator.GMT.G9731F11U | 100 | 61.6 | 96.6 | |
| 4 | U32 | (TF) 6x6.IMVP7.Dual Single-Phase PWM.Richtek.RT8167AGQW | 100 | 61.1 | 96.1 | |
| 5 | U28 | (TF) PWM Controller.TSSOP-20EP.TI.LM25118MHX | 100 | 59.2 | 94.2 | |
| 6 | D25 | (TF)D Schottky.VDC=40V.3A. Barrier Rectifiers.Willas.SK34A | 100 | 61.4 | 96.4 | |
| 7 | Memory | (TF)DDR3-SDRAM.256Mx8.1.5V.SAMSUNG.K4B2G0846D-HCH9 | 95 | 50.9 | 85.9 | |
| 8 | Memory | (TF)DDR3-SDRAM.256Mx8.1.5V.SAMSUNG.K4B2G0846D-HCH9 | 95 | 52.1 | 87.1 | |
| 9 | Q22 | (TF)PWR.P-Channel.-12V.-11A.25mΩ.MOSFET.AOS.AO4437 | 125 | 63.2 | 98.2 | |
| 10 | U21 | (TF)Embedded Controller.ITE.IT8518E-L | 100 | 59.8 | 94.8 | |

Note(*):

1. "Tc" indicates the component's case maximum temperature value specified in its datasheet.
2. "Tm" indicates the measured Tc value under working environmental temperature within product specification.

3. Judgment Criteria:

- **Fail** : $T_m > T_c + 5^\circ\text{C}$; The measured value is over specification plus margin.
- **Margin** : $T_c + 5^\circ\text{C} > T_m > T_c - 10^\circ\text{C}$; The measured value is within specification with margin.
For FANLESS system application, it is strongly recommended to add thermal dissipation design for better reliability.
- **Pass** : $T_m < T_c - 10^\circ\text{C}$; The measured value is with safety margin.